5-825433-0 ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 5-825433-0

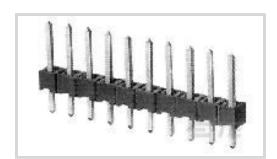
PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm

[.1 in] Centerline, Breakaway, AMPMODU Headers

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 50

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	50
Number of Rows	1
Board-to-Board Configuration	Parallel

Electrical Characteristics

Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	750 Vrms

Body Features

Primary Product Color	Green	

Contact Features

Mating Square Post Dimension .64 mm[.025 in]	Mating Square Post Dimension	.64 mm[.025 in]
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Contact Underplating Material Contact Underplating Material PCB Contact Termination Area Plating Material Contact Base Material Brass Contact Mating Area Plating Material Contact Mating Area Plating Material Contact Mating Area Plating Material Thickness Brass Contact Mating Area Plating Material Thickness Brass Contact Type Pin Contact Current Rating (Max) S A Termination Features Square Termination Post & Tail Dimension Admin_(025 in] Termination Post & Tail Length Termination Method to Printed Circuit Board Through Hole - Solder Mechanical Attachment Mating Alignment Without PCB Mount Retention PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) Losing Material PBT Dimensions
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Contact Base Material Brass Contact Mating Area Plating Material Gold or Gold Flash over Palladium Nickel Contact Mating Area Plating Material Thickness .8 \$\mu\mathrm{m}\m
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PCB Mount Retention Without PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) 2.54 mm[.1 in] Housing Material PBT
PCB Mount Alignment Without Connector Mounting Type Board Mount Housing Features Centerline (Pitch) 2.54 mm[.1 in] Housing Material PBT
Connector Mounting Type Housing Features Centerline (Pitch) Housing Material PBT
Housing Features Centerline (Pitch) Housing Material PBT
Centerline (Pitch) Housing Material 2.54 mm[.1 in] PBT
Housing Material PBT
Dimensions
PCB Thickness (Recommended) 1.57 mm[.062 in]
Usage Conditions
Housing Temperature Rating Standard
Operating Temperature Range -65 – 105 °C[-85 – 221 °F]
Operation/Application
Circuit Application Signal
Industry Standards
Compatible With Agency/Standards Products CSA, UL
Compatible With Approved Standards Products CSA LR7189, UL E28476
UL Flammability Rating UL 94V-0



Packaging Features

Packaging Quantity	500
Packaging Type	Box

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



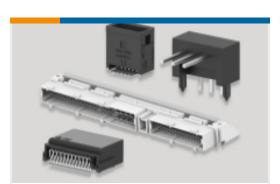
Also in the Series | AMPMODU Headers









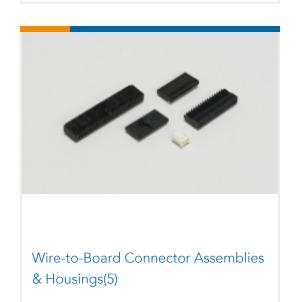


Connector Caps & Covers(1)

Connector Contacts(64)

Connector Hardware(2)

PCB Headers & Receptacles(4379)



Customers Also Bought



TE Part #647402-6 06P SL156 HSG W/RMP&TABS,OVSZ



TE Part #5-826634-0 MOD2 PIN HEADER 50P







TE Part #EFN30-5KN-C20022 FN3030-5KN-/Z05/L8M



Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-825433-0_S.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-825433-0_S.3d_igs.zip

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



English

Customer View Model

ENG_CVM_CVM_5-825433-0_S.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU Interconnetion System

AMPMODU Interconnetion System

English